

# Changwoo Lee

Curriculum Vitae

CONTACT INFORMATION	1301 Beal Avenue, Ann Arbor, MI, 48109, USA Email: <a href="mailto:cwoolee@umich.edu">cwoolee@umich.edu</a> Website: <a href="https://changwoolee.github.io/">https://changwoolee.github.io/</a>
EDUCATION	<b>University of Michigan</b> , Ann Arbor, Michigan, USA <ul style="list-style-type: none"><li>• Ph.D. in Electrical and Computer Engineering Aug 2020 – Present<ul style="list-style-type: none"><li>◦ Advisor: Prof. Hun-Seok Kim</li><li>◦ Anticipated Graduation Date: 04/2026</li></ul></li></ul> <b>Hanyang University</b> , Seoul, Republic of Korea <ul style="list-style-type: none"><li>• M.S. in Electronics and Computer Engineering Mar 2018 – Feb 2020</li><li>• B.S. in Electronic Engineering Mar 2012 – Feb 2018</li></ul>
RESEARCH INTERESTS	Efficient Deep Learning, Structured Matrix, Numerical Linear Algebra, Hardware-aware DNN Optimization.
PROFESSIONAL EXPERIENCE	<b>Graduate Student Research Assistant</b> Aug 2020 – Present University of Michigan, Ann Arbor, MI, USA <ul style="list-style-type: none"><li>• Investigating hardware-friendly, adaptive and learnable structured matrix for DNN training, fine-tuning, and inference acceleration</li><li>• Proposed generalizable and learnable structured matrix for differentiable DNN compression</li><li>• Applied latent-denoising score function estimator to improve efficiency of deep joint source-channel coding</li></ul> <b>Research Intern</b> May 2025 – Aug 2025 Google Deep Mind, Mountain View, CA, USA <ul style="list-style-type: none"><li>• Studied a dynamic inference algorithm to improve the efficiency of audio encoders of multi-modal LLMs.</li></ul> <b>NLP Research Intern</b> May 2024 – Aug 2024 Samsung Research America, Mountain View, CA, USA <ul style="list-style-type: none"><li>• Investigated efficient fine-tuning methods for on-device foundation models.</li></ul>
PREPRINTS	<ul style="list-style-type: none"><li>• P. Abillama, <b>C. Lee</b>, J. Dong, and H. Kim. “Memory-Efficient Acceleration of Block Low-Rank Foundation Models on Resource Constrained GPUs.” Submitted to ICLR 2026.</li></ul>
PUBLICATIONS	<ul style="list-style-type: none"><li>• C. Yaras, A. S. Xu, P. Abillama, <b>C. Lee</b>, and L. Balzano. “MonarchAttention: Zero-Shot Conversion to Fast, Hardware-Aware Structured Attention.” Accepted to <i>NeurIPS 2025</i> (Spotlight). [<a href="#">Paper</a>]</li><li>• P. Abillama, <b>C. Lee</b>, A. Bejarano-Carbo, D. Blaauw, and H. Kim. “One-Hot Multi-Level Leaky Integrate-and-Fire Spiking Neural Networks for Enhanced Accuracy-Latency Tradeoff.” <i>IEEE Access</i>, 2025.</li><li>• <b>C. Lee</b>, S. Kwon, Q. Qu, and H. Kim. “BLAST: Block-Level Adaptive Structured Matrices for Efficient Deep Neural Network Inference.” <i>Neural Information Processing Systems (NeurIPS)</i>, 2024. [<a href="#">Paper</a>]</li><li>• Z. Fan, H. An, B. Xu, L. Xu, C.W. Tseng, Y. Peng, A. Bejarano-Carbo, P. Abillama, A. Cao, B. Liu, <b>C. Lee</b>, Z. Wang, H. Kim, D. Blaauw, and D. Sylvester. “AIMMI: Audio and Image Multi-Modal Intelligence via a Low-Power SoC With 2-MByte On-Chip MRAM for IoT Devices.” <i>IEEE Journal of Solid-State Circuits (JSSC)</i>, 2024. [<a href="#">Paper</a>]</li></ul>

- **C. Lee** and H. Kim. “Differentiable Learning of Generalized Structured Matrices for Efficient Deep Neural Networks.” In *International Conference on Learning Representations (ICLR)*, 2024. [[Paper](#)]
- Z. Fan, Q. Zhang, P. Abillama, S. Shoouri, **C. Lee**, D. Blaauw, H. Kim, and D. Sylvester. “TaskFusion: An Efficient Transfer Learning Architecture with Dual Delta Sparsity for Multi-Task Natural Language Processing.” In *Proceedings of the 50th Annual International Symposium on Computer Architecture (ISCA)*, 2023. [[Paper](#)]
- C. Bian, C. Hsu, **C. Lee**, and H. Kim. “Learning-Based Near-Orthogonal Superposition Code for MIMO Short Message Transmission.” In *IEEE Transactions on Communications (TCOM)*, 2023. [[Paper](#)]
- **C. Lee**, X. Hu, and H. Kim “Deep Joint Source-Channel Coding with Iterative Source Error Correction.” In *International Conference on Artificial Intelligence and Statistics (AISTATS)*, 2023. [[Paper](#)]
- Z. Fan, H. An, Q. Zhang, B. Xu, L. Xu, C. Tseng, Y. Peng, A. Cao, B. Liu, **C. Lee**, Z. Wang, F. Liu, G. Wang, S. Jiang, H. Kim, D. Blaauw, D. Sylvester. “Audio and Image Cross-Modal Intelligence via a 10TOPS/W 22nm SoC with Back-Propagation and Dynamic Power Gating.” In *IEEE Symposium on VLSI Circuits (VLSI-Symposium)*, 2022. [[Paper](#)]
- D. Kim, **C. Lee**, and K.S. Chung. “A Confidence-Calibrated MOBA Game Winner Predictor.” In *IEEE Conference on Games (CoG)*, 2020. [[Paper](#)]
- **C. Lee**, and K.S. Chung. “GRAM: Gradient Rescaling Attention Model for Data Uncertainty Estimation in Single Image Super Resolution.” In *IEEE International Conference on Machine Learning and Applications (ICMLA)*, 2019. [[Paper](#)]

TALK **SPEECS Seminar** on Generalized Block Low-Rank Structured Matrices. Ann Arbor, MI, USA. [\[Link\]](#) Mar 4 2024

SKILLS **Programming Languages and Frameworks.** Python, PyTorch, NumPy.  
**Relevant Courses.**

- Umich EECS 501 Probability and Random Processes
- Umich EECS 551 Matrix Methods for Signal Processing, Data Analysis and Machine Learning
- Umich EECS 559 Optimization Methods in Signal Processing and Machine Learning
- Umich EECS 600 Function Space Methods in System Theory
- Umich EECS 598 Special Topics: Randomized Numerical Linear Algebra for Machine Learning
- Umich EECS 598 Special Topics: Statistical Learning Theory

TEACHING EXPERIENCE

- Embedded System, Hanyang University Spring 2019
- VLSI Design, Hanyang University Fall 2018
- SoC Design, Hanyang University Spring 2018

AWARDS & SCHOLARSHIPS

- Hanyang University TA Scholarship Spring 2019
- Hanyang Graduate School Scholarship (4 semesters) 2018-2019
- Hanyang Brain Scholarship (2 semesters) 2017
- Undergraduate Scholarship, Korean Government, Korea Student Aid Foundation Fall 2016
- Undergraduate Scholarship, Hanyang University (2 semesters) 2012-2013

SERVICE **Review Experience.**

- NeurIPS 2025, ICML 2024, AISTATS 2024, ICLR 2024, NeurIPS 2024, IEEE Transactions on Communications, IEEE Transactions on Mobile Computing